

Substitute for form 1449A/B/PTO				Complete if Known	
INFORMATION DISCLOSURE STATEMENT BY APPLICANT <i>(Use as many sheets as necessary)</i>				Application Number	10/805,875 – Conf. #9876
				Filing Date	March 22, 2004
				First Named Inventor	Alexander I. Yatskov
				Art Unit	2835
				Examiner Name	Zachary M. Pape
Sheet	1	of	2	Attorney Docket Number	324758025US

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Examiner Initials*	Cite No. ¹	Document Number	Publication Date MM-DD-YYYY	Name of Patentee or Applicant of Cited Document	Pages, Columns, Lines, Where Relevant Passages or Relevant Figures Appear
		Number-Kind Code ² (if known)			
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NON PATENT LITERATURE DOCUMENTS				
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